# Silicon Controlled Rectifiers Reverse Blocking Thyristors

Designed for overvoltage protection in crowbar circuits.

### Features

- Glass-Passivated Junctions for Greater Parameter Stability and Reliability
- Center-Gate Geometry for Uniform Current Spreading Enabling High Discharge Current
- Small Rugged, Thermowatt Package Constructed for Low Thermal Resistance and Maximum Power Dissipation and Durability
- High Capacitor Discharge Current, 300 Amps
- Pb–Free Package is Available\*

#### **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Off–State Voltage (Note 1) ( $T_J = -40$ to +125°C, Gate Open) MCR68–2	V <sub>DRM,</sub> V <sub>RRM</sub>	50	V	
Peak Discharge Current (Note 2)	I <sub>TM</sub>	300	А	
On-State RMS Current (180° Conduction Angles; T <sub>C</sub> = 85°C)	I <sub>T(RMS)</sub>	12	A	
Average On-State Current (180° Conduction Angles; T <sub>C</sub> = 85°C)	I <sub>T(AV)</sub>	8.0	A	
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, $T_J = 125^{\circ}C$ )	I <sub>TSM</sub>	100	A	
Circuit Fusing Considerations (t = 8.3 ms)	l <sup>2</sup> t	40	A <sup>2</sup> s	
Forward Peak Gate Current (t $\leq$ 1.0 µs, T <sub>C</sub> = 85°C)	I <sub>GM</sub>	2.0	A	
Forward Peak Gate Power (t $\leq$ 1.0 $\mu$ s, T <sub>C</sub> = 85°C)	P <sub>GM</sub>	20	W	
Forward Average Gate Power (t = 8.3 ms, $T_C$ = 85°C)	P <sub>G(AV)</sub>	0.5	W	
Operating Junction Temperature Range	TJ	-40 to +125	°C	
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C	
Mounting Torque	-	8.0	in. lb.	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- 2. Ratings apply for  $t_w = 1$  ms. See Figure 1 for  $I_{TM}$  capability for various duration of an exponentially decaying current waveform,  $t_w$  is defined as 5 time constants of an exponentially decaying current pulse.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

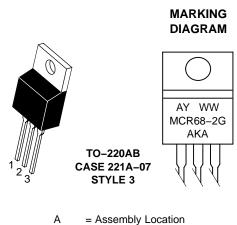


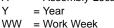
### **ON Semiconductor®**

http://onsemi.com









G = Pb-Free Package

AKA = Diode Polarity

PIN ASSIGNMENT			
1 Cathode			
2	Anode		
3	Gate		
4	Anode		

#### **ORDERING INFORMATION**

Device	Package	Shipping
MCR68-2	TO-220AB	500 Units / Box
MCR68–2G	TO–220AB (Pb–Free)	500 Units / Box

**Preferred** devices are recommended choices for future use and best overall value.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Case	$R_{\thetaJC}$	2.0	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	Τ <sub>L</sub>	260	°C

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Peak Repetitive Forward or Reverse Blocking Current ( $V_{AK}$ = Rated $V_{DRM}$ or $V_{RRM}$ , Gate Open)	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C	I <sub>DRM</sub> , I <sub>RRM</sub>	-		10 2.0	μA mA
ON CHARACTERISTICS					•	
Peak Forward On-State Voltage $(I_{TM} = 24 \text{ A})$ (Note 3) $(I_{TM} = 300 \text{ A}, t_w = 1 \text{ ms})$ (Note 4)		V <sub>TM</sub>		_ 6.0	2.2	V
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$		I <sub>GT</sub>	2.0	7.0	30	mA
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$		V <sub>GT</sub>	-	0.65	1.5	V
Gate Non–Trigger Voltage ( $V_D = 12 \text{ Vdc}, R_L = 100 \Omega, T_J = 125^{\circ}\text{C}$ )		V <sub>GD</sub>	0.2	0.40	-	V
Holding Current (V <sub>D</sub> = 12 V, Initiating Current = 200 mA, Gate Open)		I <sub>Н</sub>	3.0	15	50	mA
Latching Current $(V_D = 12 \text{ Vdc}, I_G = 150 \text{ mA})$		۱L	-	-	60	mA
Gate Controlled Turn-On Time (Note 5) ( $V_D$ = Rated $V_{DRM}$ , $I_G$ = 150 mA) ( $I_{TM}$ = 24 A Peak)		t <sub>gt</sub>	-	1.0	-	μs
DYNAMIC CHARACTERISTICS						
Critical Rate-of-Rise of Off-State Voltage $(V_D = Rated V_{DRM}, Gate Open, Exponential Waveform, T_J = Rated V_{DRM}$	= 125°C)	dv/dt	10	-	-	V/μs

Critical Rate-of-Rise of On-State Current  $I_G = 150 \text{ mA}$ 

3. Pulse duration ≤ 300 μs, duty cycle ≤ 2%.
4. Ratings apply for t<sub>w</sub> = 1 ms. See Figure 1 for I<sub>TM</sub> capability for various durations of an exponentially decaying current waveform. t<sub>w</sub> is defined as 5 time constants of an exponentially decaying current pulse.

T<sub>J</sub> = 125°C

di/dt

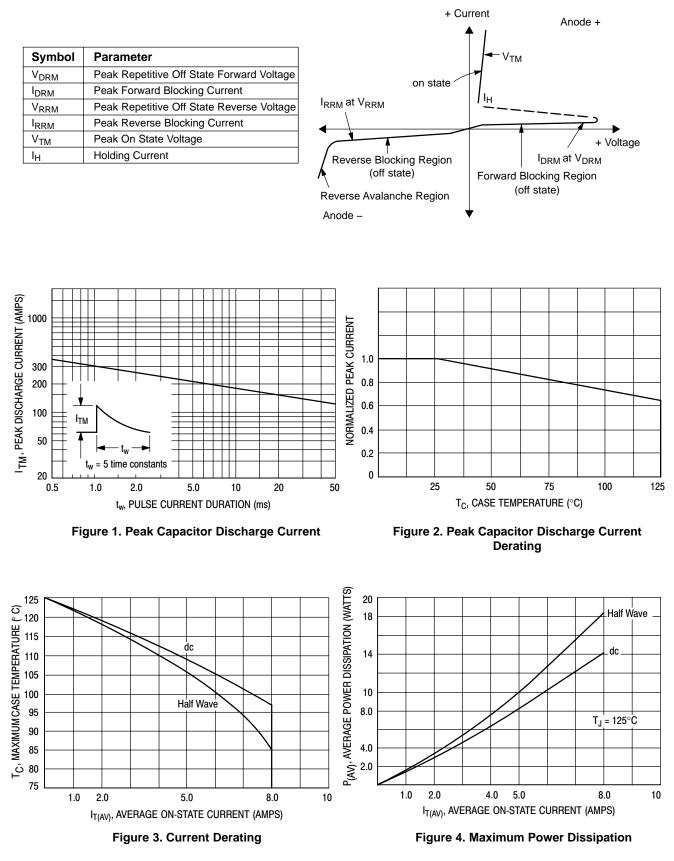
75

A/μs

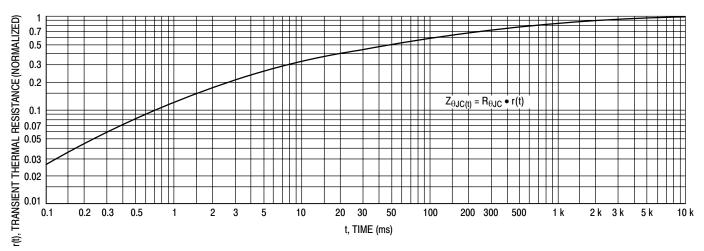
5. The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

# MCR68-2

### Voltage Current Characteristic of SCR



# MCR68-2





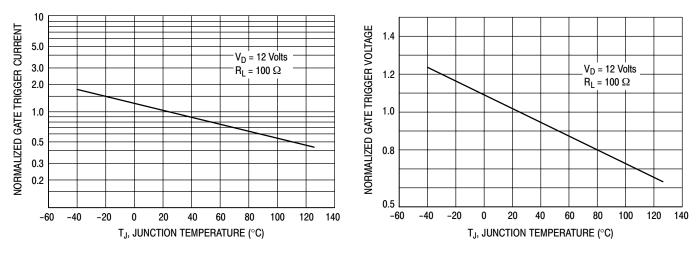


Figure 6. Gate Trigger Current

Figure 7. Gate Trigger Voltage

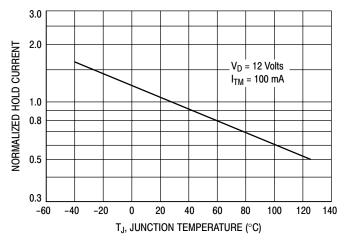
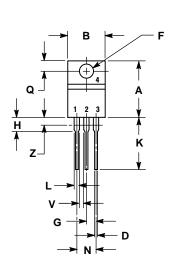
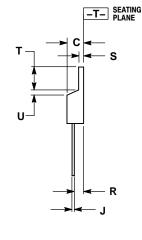


Figure 8. Holding Current

#### PACKAGE DIMENSIONS

**TO-220AB** CASE 221A-07 **ISSUE AA** 





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.022	0.36	0.55	
Κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Ζ		0.080		2.04	

STYLE 3: PIN 1. CATHODE ANODE GATE 2. 3

4. ANODE

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